

# **800V Super-junction Power MOSFET**

### Description

#### 800V Super-junction Power MOSFET

Super-junction power MOSFET is a revolutionary technology for high voltage power MOSFETs, designed according to the SJ principle. The Multi-EPI SJ MOSFET provide an extremely low switching, communication and conduction losses device with highest robustness make especially resonant switching applications more reliable, more efficient, lighter and cooler, designed by Wuxi Unigroup Microelectronics Company.

Features		Applications		
● Very low FOM R <sub>DS(on)</sub> ×Q <sub>q</sub>		<ul> <li>Switch Mode Power Supply (SMPS)</li> </ul>		
<ul> <li>100% avalanche tested</li> </ul>		<ul> <li>Uninterruptible Power Supply (UPS)</li> </ul>		
• Easy to use/drive		Power Factor Correction (PFC)		
RoHS compliant		Low Power Chargers and Adapters		
TO-220		Drain		
S P S	Gate	RoHS Source		
Device Marking and Pa	ckage Information			
Device	Package	Marking		
TPP80R270M	TO-220	80R270M		
Key Performance Par	ameters			
Parameter	Value	Unit		
V <sub>DS</sub> @ T <sub>j,max</sub>	850	V		
R <sub>DS(on),max</sub>	0.27	Ω		
Q <sub>g,typ</sub>	38.5	nC		
I <sub>D</sub>	17	A		
I <sub>D,pulse</sub>	51	A		
E <sub>OSS</sub> @ 400V	3.58	μJ		
Body Diode di <sub>F</sub> /dt	500	A/µs		



Absolute Maximum Ratings T <sub>C</sub> = 25°C, unless otherwise noted						
Parameter			Symbol	Values	Unit	
Continuous Drain Current	T <sub>C</sub> = 25°C			17		
	T <sub>C</sub> = 100°C		I <sub>D</sub>	10.2	- A	
Pulsed Drain Current		note1)	I <sub>D,pulse</sub>	51	А	
Gate-Source Voltage			V <sub>GSS</sub>	±30V	V	
Single Pulse Avalanche Energy		note2)	E <sub>AS</sub>	256	mJ	
Repetitive Avalanche Energy		note2)	E <sub>AR</sub>	0.7	mJ	
Avalanche Current			I <sub>AR</sub>	3.5	А	
MOSFET dv/dt Ruggedness, V <sub>DS</sub> = 0480V			dv/dt	50	V/ns	
Power Dissipation For TO-220F			P <sub>D</sub>	151	W	
Continuous Diode Forward Current			ا <sub>s</sub>	17	A	
Diode Pulsed Current		note1)	I <sub>S,pulse</sub>	51		
Reverse Diode dv/dt		note3)	dv/dt	15	V/ns	
Maximum Diode Commutation Speed (not		note3)	di <sub>f</sub> /dt	500	A/µs	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55~+150	°C	

Thermal Resistance For TO-220					
Parameter	Symbol	Value	Unit		
Thermal Resistance, Junction-to-Case	R <sub>thJC</sub>	0.83	°C/W		
Thermal Resistance, Junction-to-Ambient	R <sub>thJA</sub>	62			



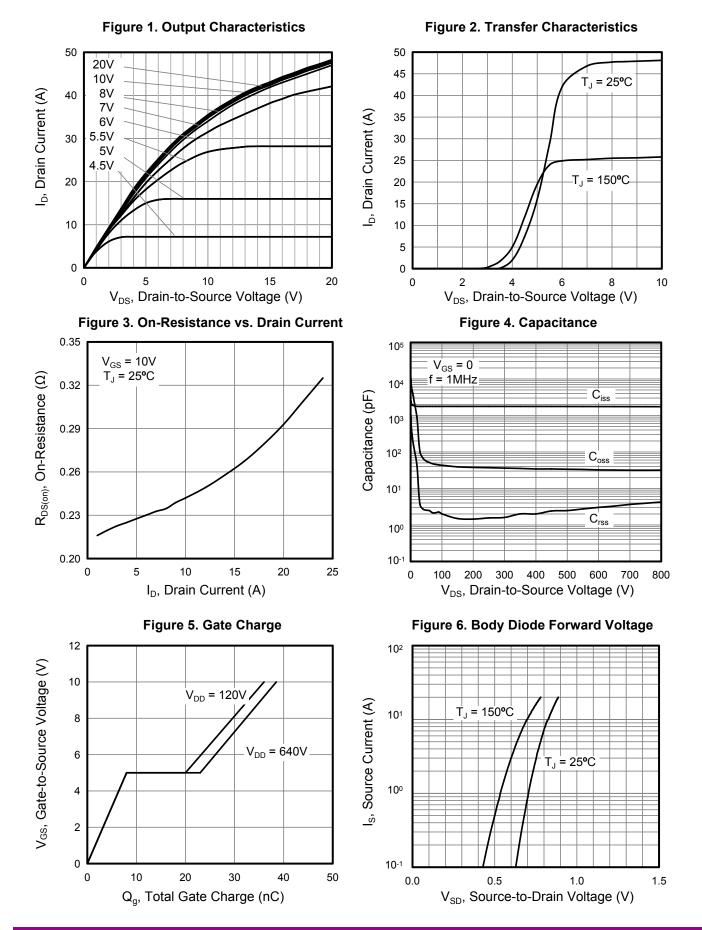
<b>Electrical Characteristics</b> $T_J = 25^{\circ}C$ , unless otherwise noted						
Demonster			Value			
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0V, $I_{D}$ = 250µA	800			V
		V <sub>DS</sub> = 800V, V <sub>CS</sub> = 0V, T <sub>1</sub> = 25°C			1	μΑ
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0V, T_J = 25^{\circ}C$ $V_{DS} = 800V,$ $V_{GS} = 0V, T_J = 150^{\circ}C$			100	
Gate-Source Leakage Current	I <sub>GSS</sub>	$V_{GS} = \pm 30V$			±100	nA
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	2.5		4.5	V
Drain-Source On-State-Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10V, I_{D} = 8.5A$		0.24	0.27	Ω
Gate Resistance	R <sub>G</sub>	f = 1.0MHz open drain		3.8		Ω
Dynamic Characteristics						
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V,		1776.8		pF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 100V		41.25		
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0MHz		2.01		
Total Gate Charge	Q <sub>g</sub>	V <sub>DD</sub> = 640V,		38.5		nC
Gate-Source Charge	$Q_gs$	I <sub>D</sub> =17A,		8		
Gate-Drain Charge	$Q_gd$	$V_{GS}$ = 10V		15		
Turn-on Delay Time	t <sub>d(on)</sub>			15		ns
Turn-on Rise Time	t <sub>r</sub>	$V_{DD} = 400V$		59		
Turn-off Delay Time	t <sub>d(off)</sub>	$I_D = 17A$ $R_G = 25\Omega$		121		
Turn-off Fall Time	t <sub>f</sub>			44		
Drain-Source Body Diode Character	ristics					
Body Diode Forward Voltage	V <sub>SD</sub>	$T_J = 25^{\circ}C, I_{SD} = 8.5A, V_{GS} = 0V$		0.9	1.2	V
Reverse Recovery Time	t <sub>rr</sub>	V <sub>R</sub> = 400		38.5		ns
Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = 17A,		8		μC
Peak Reverse Recovery Current	l <sub>rrm</sub>	di <sub>F</sub> /dt = 100A/µs		15		А

#### Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2.  $I_D$  = 10A,  $V_{DD}$  = 50V,  $R_G$  = 25 $\Omega$ , Starting  $T_J$  = 25°C
- 3. Identical low side and high side switch with identical  ${\sf R}_{\sf G}$



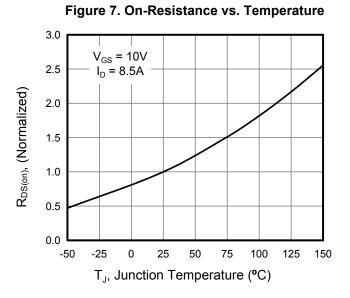
### Typical Characteristics $T_J = 25^{\circ}C$ , unless otherwise noted

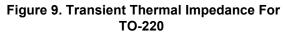


#### www.tsinghuaicwx.com



### **Typical Characteristics** $T_J = 25^{\circ}C$ , unless otherwise noted





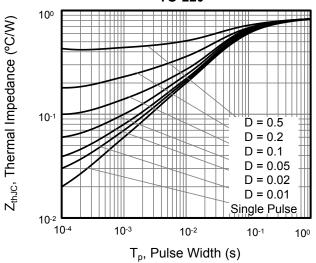
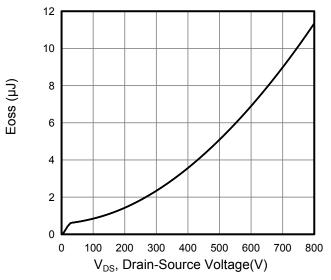


Figure 11. Typ. Coss Stored Energy



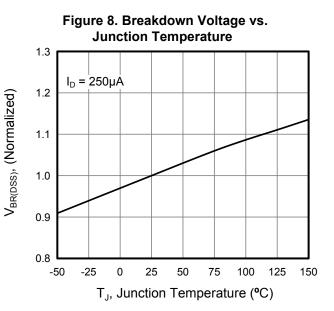
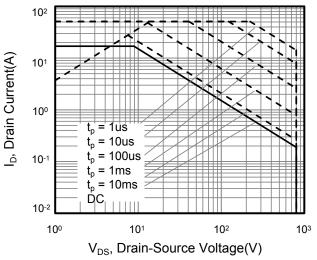


Figure 10. Safe Operation Area For TO-220





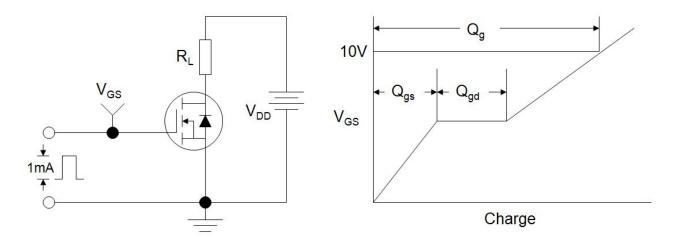


Figure B: Resistive Switching Test Circuit and Waveform

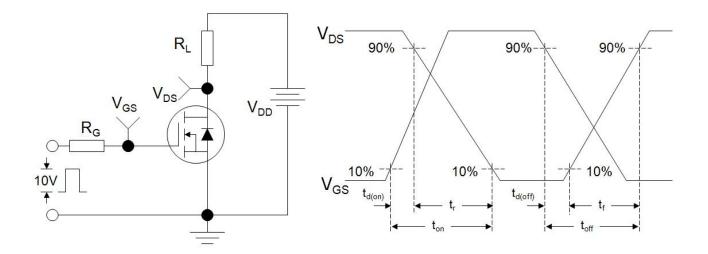
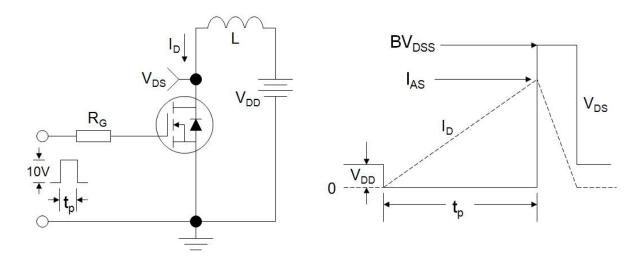
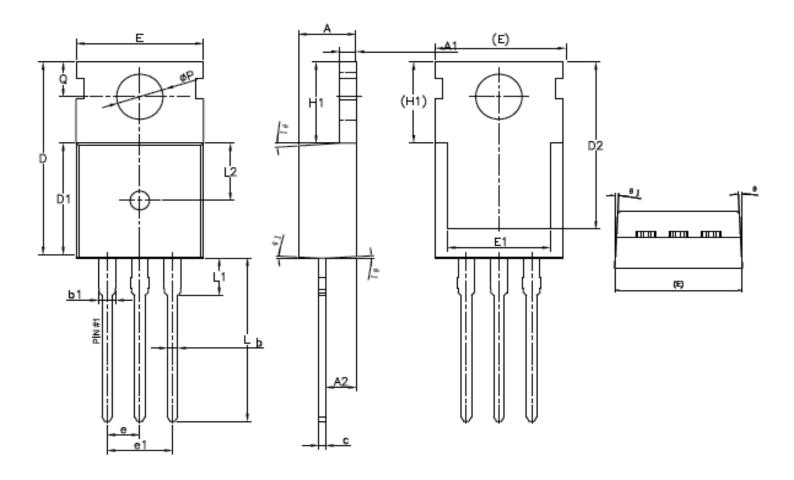


Figure C: Unclamped Inductive Switching Test Circuit and Waveform





TO-220(集佳)



SYMBOL	MIN	NOM	MAX	
Α	4.40	4.50	4.60	
A1	1.27	1.30	1.33	
A2	2.30	2.40	2.50	
b	0.70	Ι	0.90	
b1	1.27	Ι	1.40	
c	0.45	0.50	0.60	
D	15.30	15.70	16.10	
D1	9.10	9.20	9,30	
D2	13.10	Ι	13.70	
E	9.70	9.90	10.20	
E1	7.80	8.00	8.20	
e	2.54BSC			
e1	5.08BSC			
H1	6.30	6.50	6.70	
L	12.78	13.08	13.38	
L1	-	-	3.50	
L2	4.60REF			
øP	3.55	3.60	3.65	
Q	2.73	Ι	2.87	
01	1'	3'	5*	



## Disclaimer

All product specifications and data are subject to change without notice.

For documents and material available from this datasheet, Wuxi Unigroup does not warrant or assume any legal liability or responsibility for the accuracy, completeness of any product or technology disclosed hereunder.

No license, express or implied, by estoppels or otherwise, to any intellectual property rights is granted by this document or by any conduct of Wuxi Unigroup.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling Wuxi Unigroup products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Wuxi Unigroup for any damages arising or resulting from such use or sale.

Wuxi Unigroup disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Wuxi Unigroup's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

Wuxi Unigroup Microelectronics CO., LTD. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.

In the event that any or all Wuxi Unigroup products (including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.

Information (including circuit diagrams and circuit parameters) herein is for example only. It is not guaranteed for volume production. Wuxi Unigroup believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.